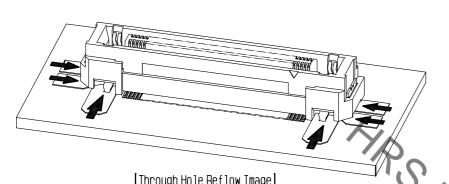
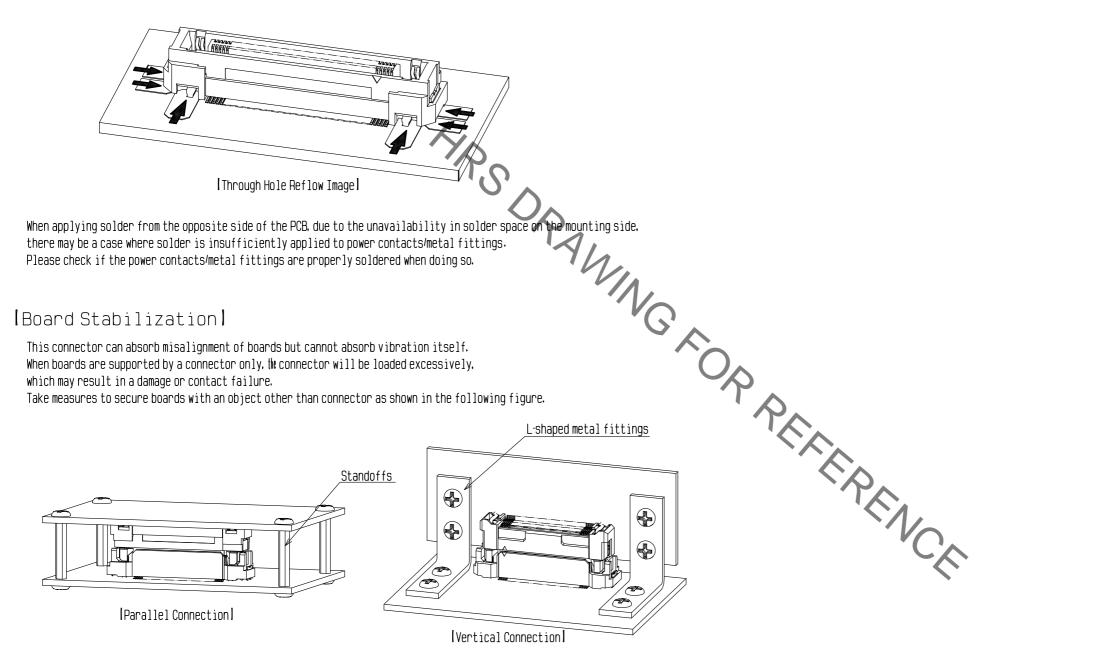


In order to prevent any potential failures with the connector, please read the following below:

Through Hole Reflow Process

FX23 and FX23L Series use through hole reflow process, where power contacts/metal fittings draw solder paste from the surrounding area. In regards to the soldering paste print area. the surface shall be flat with no exposed copper surface. If the surface is not flat, power contacts/metal fittings may not properly draw the soldering paste. resulting insufficient solder on the power contacts/metal fittings as well as ball-shaped solw on the PCB.





Note that when A spacer is installed far from connectors, incomplete mating of the connectors may occur due to sagging of the board, etc. Mate connectors surely and then fix a spacer.

In Regards to Design Guideline

To provide more information in regards to the usage of this product, we have prepared a detailed manual (ETAD-F0887-00).

Please contact our sales representative if needed.

EDC-353539-20-00 FX23-60P-0.5SV15(20) CL0573-3003-6-20

Added the third page

FORM HC0011-5-8

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Hirose Electric: FX23-60P-0.5SV15(20)